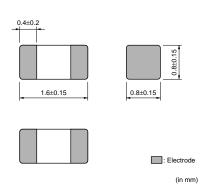
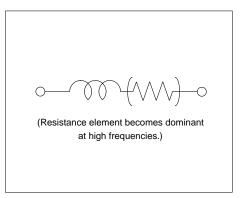
EMIFIL® (Inductor type) Chip Ferrite Bead for GHz Noise

BLM18H Series (0603 Size)

■ Dimensions



■ Equivalent Circuit



■ Packaging

Code	Packaging	Minimum Quantity	
D	180mm Paper Tape	4000	
J	330mm Paper Tape	10000	
В	Bulk(Bag)	1000	

■ Rated Value (□: packaging code)

Part Number	Impedance (at 100MHz/20°C)	Impedance (at 1GHz/20°C)	Rated Current	DC Resistance (max.)	Operating Temperature Range
BLM18HG471SN1□	470ohm±25%	600ohm(Typ.)	200mA	0.85ohm	-55 to +125°C
BLM18HG601SN1□	600ohm±25%	700ohm(Typ.)	200mA	1.00ohm	-55 to +125°C
BLM18HG102SN1□	1000ohm±25%	1000ohm(Typ.)	100mA	1.60ohm	-55 to +125°C
BLM18HE601SN1□	600ohm±25%	600ohm(Typ.)	800mA	0.25ohm	-55 to +125°C
BLM18HE102SN1□	1000ohm±25%	1000ohm(Typ.)	600mA	0.35ohm	-55 to +125°C
BLM18HE152SN1□	1500ohm±25%	1500ohm(Typ.)	500mA	0.50ohm	-55 to +125°C
BLM18HD471SN1□	470ohm±25%	1000ohm(Typ.)	100mA	1.20ohm	-55 to +125°C
BLM18HD601SN1□	600ohm±25%	1200ohm(Typ.)	100mA	1.50ohm	-55 to +125°C
BLM18HD102SN1□	1000ohm±25%	1700ohm(Typ.)	50mA	1.80ohm	-55 to +125°C
BLM18HB121SN1□	120ohm±25%	500ohm±40%	200mA	0.50ohm	-55 to +125°C
BLM18HB221SN1□	220ohm±25%	1100ohm±40%	100mA	0.80ohm	-55 to +125°C
BLM18HB331SN1□	330ohm±25%	1600ohm±40%	50mA	1.20ohm	-55 to +125°C
BLM18HK331SN1□	330ohm±25%	400ohm±40%	200mA	0.50ohm	-55 to +125°C
BLM18HK471SN1□	470ohm±25%	600ohm±40%	200mA	0.70ohm	-55 to +125°C
BLM18HK601SN1□	600ohm±25%	700ohm±40%	100mA	0.90ohm	-55 to +125°C
BLM18HK102SN1□	1000ohm±25%	1200ohm±40%	50mA	1.50ohm	-55 to +125°C

Number of Circuits: 1

Continued on the following page.

31.3.

⚠ Note:

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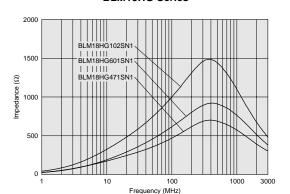
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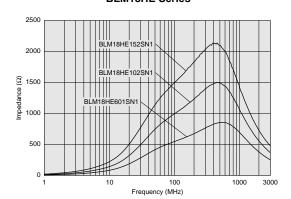
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■ Impedance-Frequency Characteristics (Main Items)

BLM18HG Series

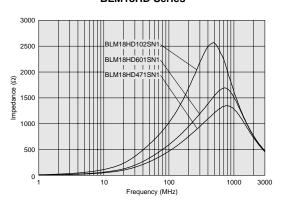


■ Impedance-Frequency Characteristics (Main Items)
BLM18HE Series

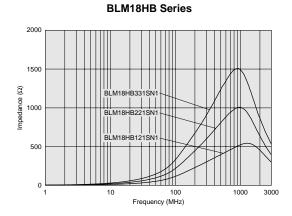


■ Impedance-Frequency Characteristics (Main Items)

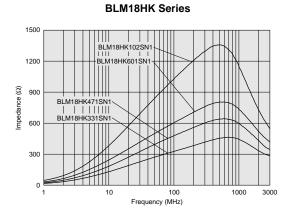
BLM18HD Series



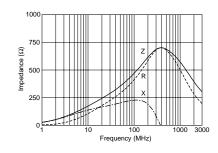
■ Impedance-Frequency Characteristics (Main Items)



■ Impedance-Frequency Characteristics (Main Items)



■ Impedance-Frequency Characteristics
BLM18HG471SN1



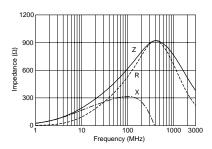
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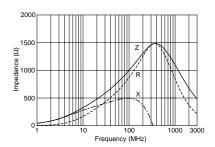
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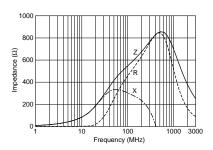
■ Impedance-Frequency Characteristics BLM18HG601SN1



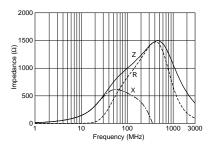
■ Impedance-Frequency Characteristics BLM18HG102SN1



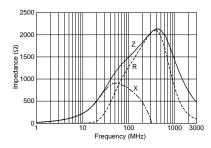
■ Impedance-Frequency Characteristics BLM18HE601SN1



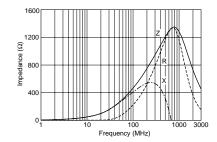
■ Impedance-Frequency Characteristics BLM18HE102SN1



■ Impedance-Frequency Characteristics BLM18HE152SN1



■ Impedance-Frequency Characteristics BLM18HD471SN1



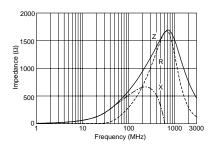
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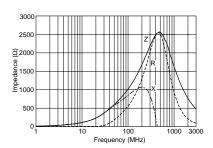
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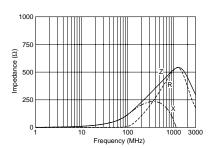
■ Impedance-Frequency Characteristics BLM18HD601SN1



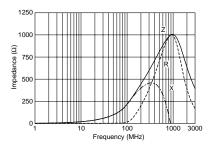
■ Impedance-Frequency Characteristics BLM18HD102SN1



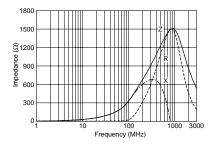
■ Impedance-Frequency Characteristics BLM18HB121SN1



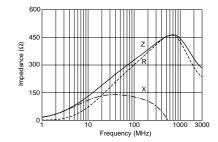
■ Impedance-Frequency Characteristics BLM18HB221SN1



■ Impedance-Frequency Characteristics BLM18HB331SN1



■ Impedance-Frequency Characteristics **BLM18HK331SN1**



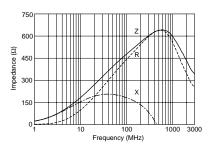
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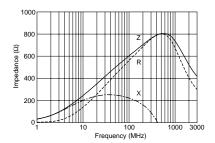
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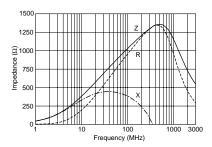
■ Impedance-Frequency Characteristics BLM18HK471SN1



■ Impedance-Frequency Characteristics BLM18HK601SN1



■ Impedance-Frequency Characteristics BLM18HK102SN1



■ ①Caution/Notice

Do not use products beyond the rated current as this may create excessive heat and deteriorate the insulation resistance.

Notice

Solderability of Tin plating termination chip might be deteriorated when low temperature soldering profile where peak solder temperature is below the Tin melting point is used. Please confirm the solderability of Tin plating termination chip before use.

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